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WHAT IS CLAIMED IS:

1. A display device comprising:
a first substrate;
an organic light emitting element over the first substrate; and
a second substrate which is translucent, the second substrate bonded to the first substrate through a layer having adhesion,
wherein a surface of the second substrate opposing the first substrate comprises a first region and a second region, the first region is adhered with the layer having adhesion, and the second region is located inside the first region and concaved relative to the first region.
2. A display device according to claim 1, wherein the first substrate is a glass substrate.
3. A display device according to claim 1, wherein the first substrate and the second substrate are a glass substrate.
4. A display device according to claim 1, wherein a thickness of the layer having adhesion is 10 μm or less.
5. A display device according to claim 1, wherein the display device is an active matrix display device.
6. A display device according to claim 1, wherein the display device is a passive matrix display device.
7. A display device comprising;
a first substrate;
an organic light emitting element over the first substrate; and

a second substrate which is translucent, the second substrate bonded to the first substrate through a layer having adhesion,

wherein a surface of the second substrate opposing the first substrate comprises a first region, a second region, and a third region, the first region is adhered with the layer having adhesion, the second region is located inside the first region and concaved relative to the first region, the third region is located inside the second region and concaved relative to the second region, and

wherein a dry agent is provided in the third region.

8. A display device according to claim 7, wherein a permeable film is adhered to a portion of the second region to thereby contain the dry agent in the third region.

9. A display device according to claim 8, wherein the permeable film is provided so that a bottom surface of the permeable film is not contact with the first substrate.

10. A display device according to claim 8, wherein a difference in height between a bottom portion of the second region which is concaved relative to the first region and the first region is 160 μm to 350 μm .

11. A display device according to claim 7, wherein a difference in height between a bottom portion of the second region which is concaved relative to the first region and the first region is 10 μm to 50 μm .

12. A display device according to claim 7, wherein a difference in height between a bottom portion of the third region which is concaved relative to the second region and the second region is 50 μm to 150 μm .

13. A display device according to claim 7, wherein the first substrate is a glass substrate.

14. A display device according to claim 7, wherein the first substrate and the second substrate are a glass substrate.

15. A display device according to claim 7, wherein a thickness of the layer having adhesion is 10 μm or less.

16. A display device according to claim 7, wherein the display device is an active matrix display device.

17. A display device according to claim 7, wherein the display device is a passive matrix display device.

18. A display device comprising:

a first substrate;

an organic light emitting element over the first substrate;

a layer having adhesion for enclosing with a gap an area surrounding a region in which the organic light emitting element is provided on the first substrate; and

a second substrate which is translucent, the second substrate bonded to the first substrate through the layer having adhesion,

wherein a surface of the second substrate opposing the first substrate comprises a first region, a second region, and a third region, the first region is adhered with the layer having adhesion, the second region is surrounded by the first region and concaved relative to the first region, the third region is located between the layer having adhesion and an upper portion of the region in which the organic light emitting element is provided and concaved relative to the second region, and

wherein a dry agent is located in the third region.

19. A display device according to claim 18, wherein a permeable film is provided between the layer having adhesion and the upper portion of the region in which the organic light emitting element is provided, and the permeable film is adhered to a part of the

second region to thereby contain the agent in the third region.

20. A display device according to claim 19, wherein the permeable film is provided so that a bottom surface of the permeable film is not contact with the first substrate.

21. A display device according to claim 19, wherein a difference in height between a bottom portion of the second region which is concaved relative to the first region and the first region is 160 μm to 350 μm .

22. A display device according to claim 18, wherein a difference in height between a bottom portion of the second region which is concaved relative to the first region and the first region is 10 μm to 50 μm .

23. A display device according to claim 18, wherein a difference in height between a bottom portion of the third region which is concaved relative to the second region and the second region is 50 μm to 150 μm .

24. A display device according to claim 18, wherein the first substrate is a glass substrate.

25. A display device according to claim 18, wherein the first substrate and the second substrate are a glass substrate.

26. A display device according to claim 18, wherein a thickness of the layer having adhesion is 10 μm or less.

27. A display device according to claim 18, wherein the display device is an active matrix display device.

28. A display device according to claim 18, wherein the display device is a passive

matrix display device.

29. A passive matrix display device comprising:

a first substrate;

an organic light emitting element over the first substrate; and

a second substrate which is translucent, the second substrate is bonded to the first substrate through a layer having adhesion,

wherein minute unevennesses are formed on a surface of the second substrate.

30. A passive matrix display device according to claim 29, wherein height of the minute unevennesses are set to be $0.1\mu\text{m}$ to $3\mu\text{m}$.

31. A display device according to claim 29, wherein the first substrate is a glass substrate.

32. A display device according to claim 29, wherein the first substrate and the second substrate are a glass substrate.

33. A display device according to claim 29, wherein a thickness of the layer having adhesion is $10\mu\text{m}$ or less.

34. An active matrix display device comprising:

a first substrate;

at least one thin film transistor over the first substrate;

an insulating film over the thin film transistor;

an organic light emitting element over the insulating film; and

a second substrate which is translucent, the second substrate bonded to the first substrate through a layer having adhesion,

wherein minute unevennesses are formed on a surface of the second substrate.

35. A passive matrix display device according to claim 34, wherein height of the minute unevennesses are set to be $0.1\mu\text{m}$ to $3\mu\text{m}$.

36. A display device according to claim 34, wherein the first substrate is a glass substrate.

37. A display device according to claim 34, wherein the first substrate and the second substrate are a glass substrate.

38. A display device according to claim 34, wherein a thickness of the layer having adhesion is $10\mu\text{m}$ or less.

39. A method of manufacturing a display device in which a first substrate on which an organic light emitting element is provided and a second substrate bonded to the first substrate through a layer having adhesion, the method comprising:

providing a first mask in at least a first region to which the layer having adhesion is adhered;

first digging the second substrate by an abrasive machining method to form a second region which is concaved relative to the first region:

removing the first mask;

providing a second mask at least in a region where the first mask is provided and in a region located above a region where the organic light emitting element is provided:

second digging the second substrate by an abrasive machining method to thereby form a third region which is concaved relative to the second region: and

providing a dry agent in the third region.

40. A method of manufacturing a display device according to claim 39, further comprising a step of providing a permeable film in the second and the third region after the providing a dry agent in the third region.

41. A method of manufacturing a display device according to claim 40, wherein a first digging depth is larger than a thickness of the permeable film.

42. A method of manufacturing a display device according to claim 41, wherein the first digging depth is 160 μm to 350 μm .

43. A method of manufacturing a display device according to claim 40, further comprising after the providing the permeable film:

bonding the first substrate and the second substrate together through the layer having adhesion; and

cutting the first substrate and the second substrate by a gas laser.

44. A method of manufacturing a display device according to claim 43, wherein the gas laser is a CO_2 laser.

45. A method of manufacturing a display device according to claim 39, wherein a first digging depth is 10 μm to 50 μm .

46. A method of manufacturing a display device according to claim 39, wherein a second digging depth is 50 μm to 150 μm .

47. A method of manufacturing a display device according to claim 39, further comprising:

bonding the first substrate and the second substrate together through the layer having adhesion after the providing a dry agent in the third region; and

cutting the first substrate and the second substrate by a gas laser.

48. A method of manufacturing a display device according to claim 47, wherein the gas laser is a CO_2 laser.